

Package Opening Instructions

Boxed Intel® Pentium® 4 Processors & Intel® Celeron®
processors in the 478-pin package

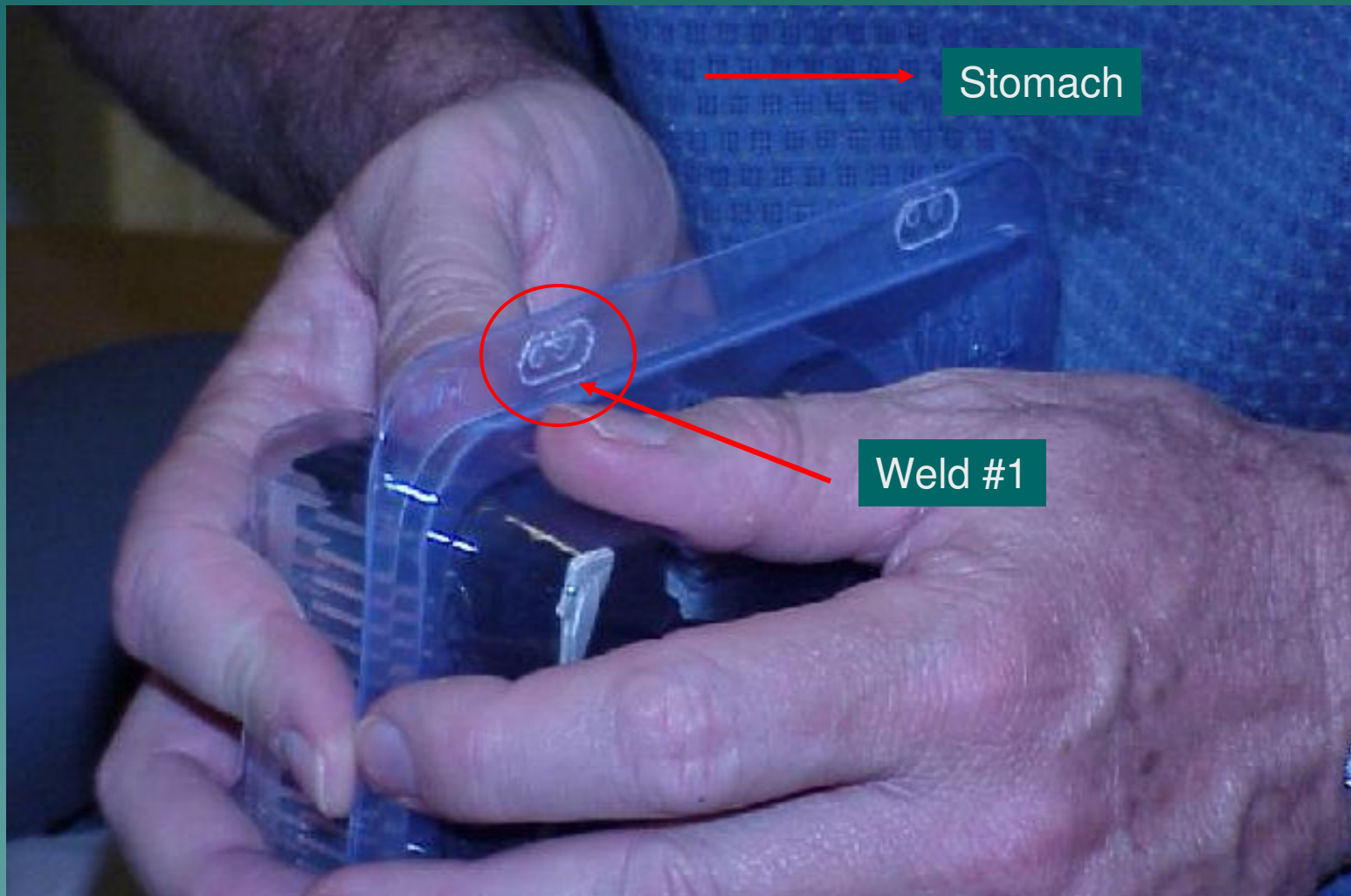
*Detailed instructions to open the plastic container
(clamshell)*

Package Opening Instructions

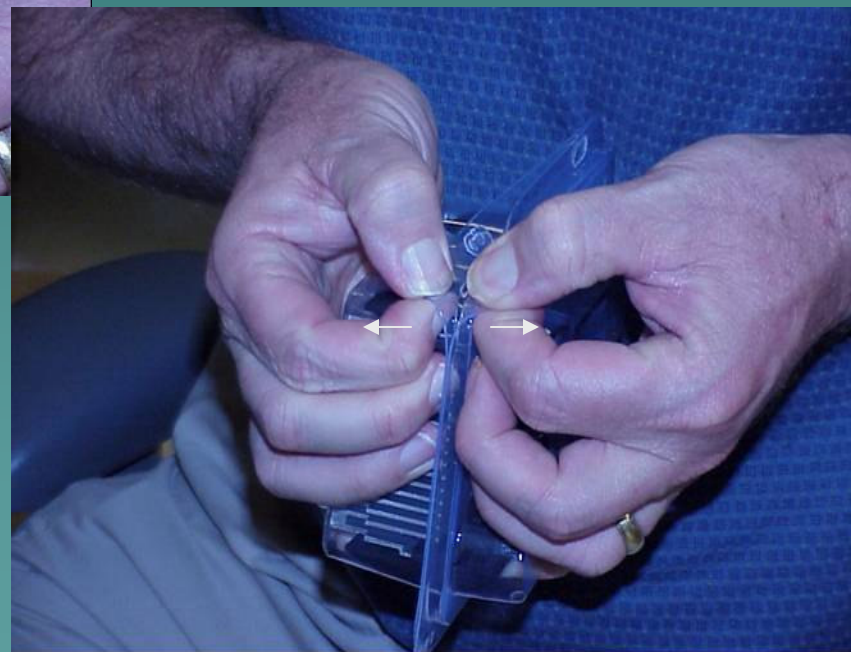
OPEN WITH CARE TO ENSURE PRODUCT IS NOT DAMAGED

- ◆ *When handling a Pentium® 4 processor or Celeron® processor in the 478 pin package, be sure to take the proper electrostatic discharge (ESD) precautions. Consider using ground straps, gloves, ESD mats, or other protective measures to avoid damaging the processor and other electrical components in the system.*
- ◆ Remove the plastic container holding the processor & fan heat sink (FHS) from the retail box and cardboard tray.

Orient the container in your lap so that you are holding the fan heat sink between both hands and that the CPU is towards your stomach with weld # 1 and the embossed “Intel” shown in the upper right hand corner is up

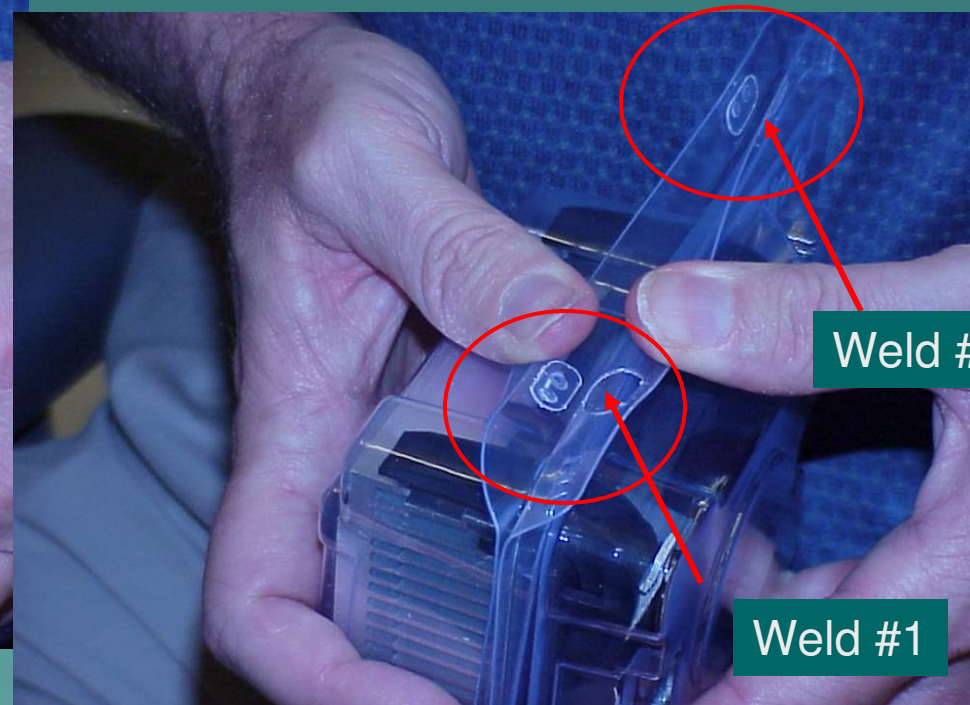


Locate the two corners of the plastic container marked “LIFT” on weld #1. These are found on the two corners closest to the FHS.



While still holding the FHS between both hands on lap, work the flanges of both the tray and lid side* of weld #1 by prying the flanges apart with your thumbs working them away from each other until weld #1 pops. Move thumbs between weld #1 and weld #3 and work towards weld #1 to completely break weld if not already broke. Again work thumbs down flange towards weld #3 to break weld #3. See [Diagram #1](#) and [Diagram #2](#) at the end of this document.

**Note: Lid side will be somewhat stiffer than tray side of clamshell.*



Work thumbs down flange towards weld to break.



Once Weld #1 & #3 are broken, reorient clamshell so that the FHS is between both hands on lap with CPU towards stomach and weld # 2 and # 4 are up. Repeat steps to break welds 2 & 4 by prying lid and tray flanges away from each other with thumbs while holding clamshell between both hands by the FHS. See [Diagram #1](#) and [Diagram #2](#) at the end of this document.

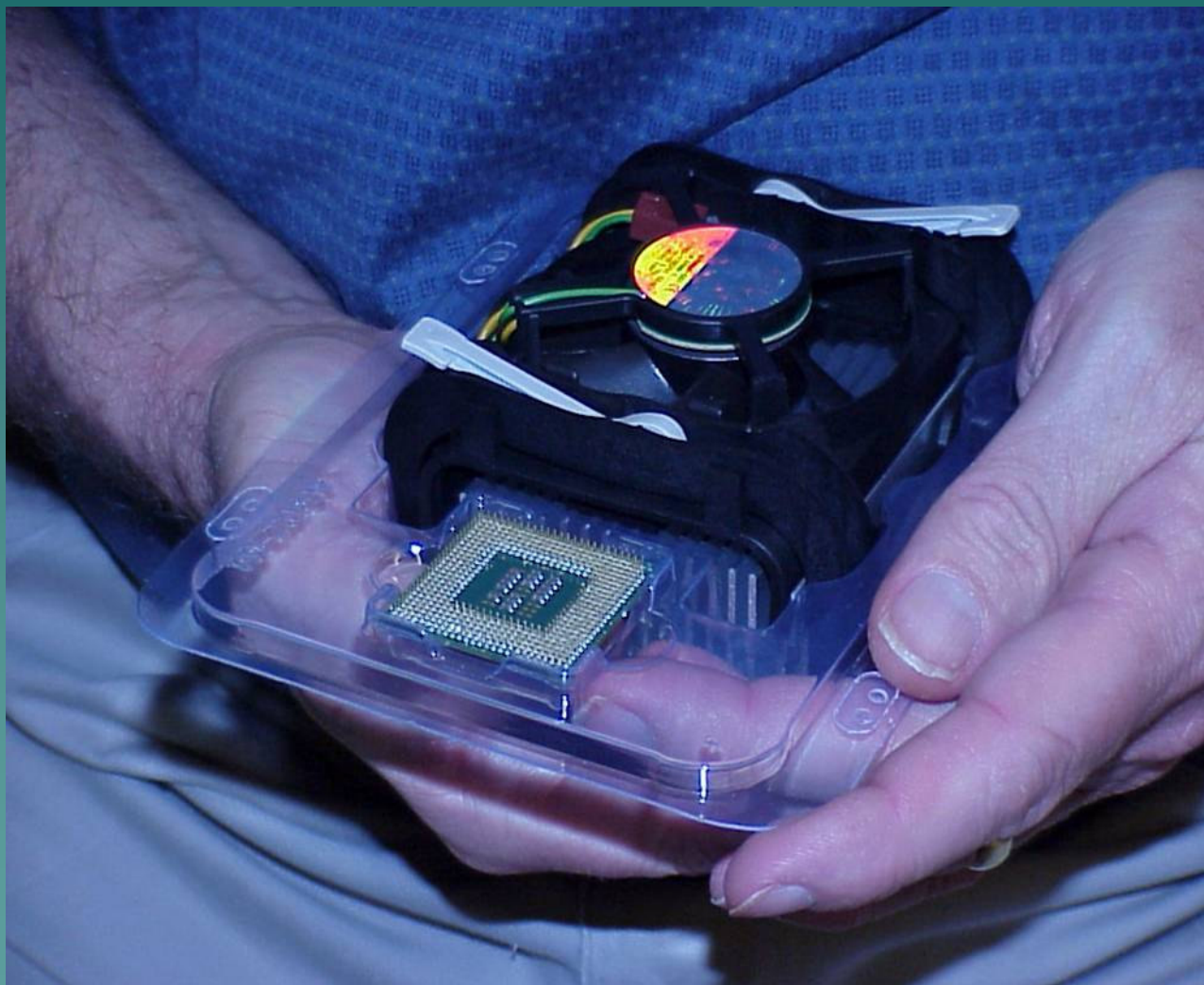


Once all four welds are broken, hold clamshell in either hand from underside of FHS so that the Intel® hologram is facing up and the container will have the embossed “Intel” showing. (Lid up) See [Diagram #2](#) at the end of this document.



Maintain grip on FHS from underneath in one hand & palm top of FHS with other hand and work both lift points first by prying with fingers at each corner until clamshell pressure is released. You may have to apply same method to opposite two corners in order to ensure complete release. You may hear a slight pop or feel a slight pop; this is normal and signifies that the pressure has been released.

The package with the lid removed.



Carefully, lift the lid off the container while maintaining grip from underside (tray side) of the FHS. Optional to set clam shell onto tabletop with hologram facing up and lift lid. The processor should be carefully lifted from the tray using the semi-circle indents to grab the green edges of the substrate of the processor.



Diagram # 1: View from top

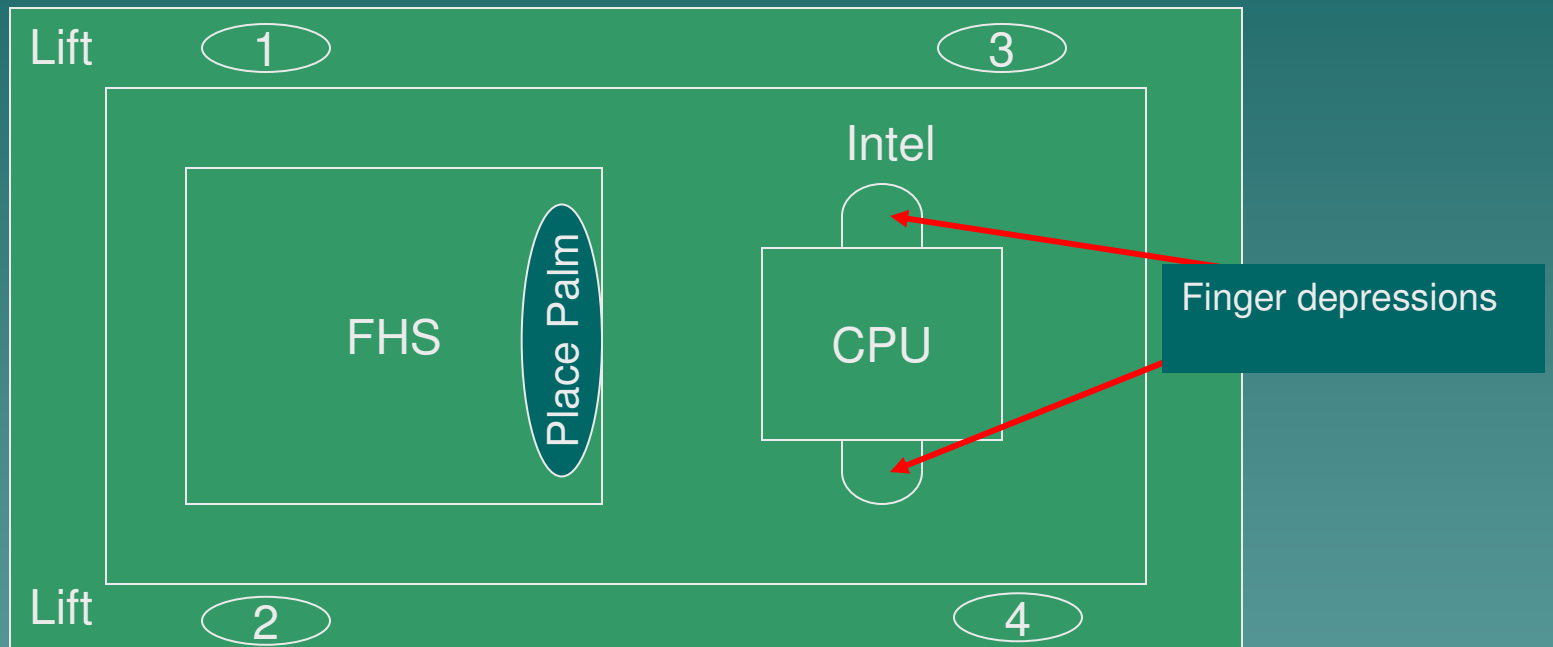


Diagram # 2: View from side

